2SC3942

Silicon NPN triple diffusion planar type

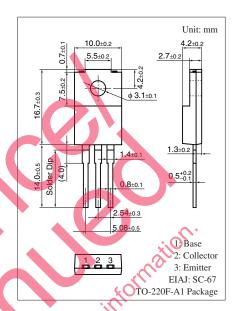
For color TV chroma output

■ Features

- ullet High collector-emitter voltage (Base open) V_{CEO}
- Small collector output capacitance (Common base, input open circuited) Cob
- Full-pack package which can be installed to the heat sink with one screw

■ Absolute Maximum Ratings $T_a = 25$ °C

Symbol	Rating	Unit	
V _{CBO}	300	V	
V _{CEO}	300	V	
V_{EBO}	7	V	
I_C	0.1	A	
I _{CP}	0.2	A	
P _C	10	W	
	2		
T_{j}	150	°C	
T _{stg}	-55 to +150	°C	
	V _{CBO} V _{CEO} V _{EBO} I _C I _{CP} P _C T _i	V _{CBO} 300 V _{CEO} 300 V _{EBO} 7 I _C 0.1 I _{CP} 0.2 P _C 10 2 T _j 150	



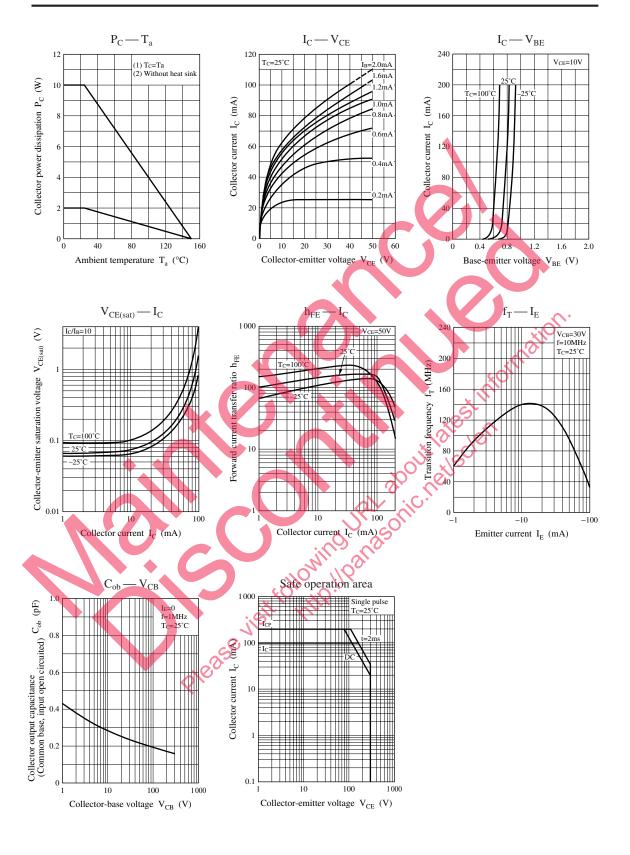
■ Electrical Characteristics $T_a = 25$ °C ± 3 °C

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage (Emitter open)	V _{CBO}	$I_{\rm C} = 10 \mu{\rm A}, I_{\rm E} = 0$	300			V
Collector-emitter voltage (Base open)	V _{CEO}	$I_Q = 1$ mA, $I_B = 0$	300			V
Emitter-base voltage (Collector open)	V _{EBO}	$I_{\rm E} = 10 \mu{\rm A}, I_{\rm C} = 0$	7			V
Base-emitter voltage	V _{BE}	$V_{CE} = 10 \text{ V}, I_{C} = 30 \text{ mA}$			1.2	V
Collector-emitter cutoff current (Base open)	ICEO	$V_{CE} = 200 \text{ V}, I_B = 0$			10	μΑ
Forward current transfer ratio	h_{FE}	$V_{CE} = 50 \text{ V}, I_{C} = 5 \text{ mA}$	50		250	_
Collector-emitter saturation voltage	V _{CE(sat)}	$I_C = 30 \text{ mA}, I_B = 3 \text{ mA}$			1.5	V
Transition frequency	f_T	$V_{CE} = 30 \text{ V}, I_{C} = 20 \text{ mA}, f = 10 \text{ MHz}$	70	140		MHz
Collector output capacitance	C _{ob}	$V_{CB} = 30 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		2.7		pF
(Common base, input open circuited)						

Note) Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

Publication date: February 2003 SJD00115CED 1

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